

TITLE: SAS CONN Rcpt S/T Hybrid Type

RELEASE DATE: 2010/3/25

REVISION: O

ECN No: ECN-1003132

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**1 Revision History**

Rev.	ECN #	Revision Description	Approved	Date
O	ECN-1003132	RELEASE	JASON	2010/3/30

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## 2 SCOPE

This specification covers performance, tests and quality requirements for [SAS connector](#).  
Refer to ACES P/N: 50911 series

## 3 APPLICABLE DOCUMENTS

**EIA-364** ELECTRONICS INDUSTRIES ASSOCIATION

## 4 REQUIREMENTS

### 4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

### 4.2 Materials and Finish

- 4.2.1 Contact: [High performance copper alloy](#)  
Plated: (a) Finish: [See Order Information](#).  
(b) Under plate: [Nickel-plated all over](#).
- 4.2.2 Housing: [Thermoplastic or Thermoplastic High Temp., UL94V-0](#)
- 4.2.3 Fitting nail: [High performance copper alloy](#)  
Plated: (a) Finish: [See Order Information](#).  
(b) Under plate: [Nickel-plated all over](#).

### 4.3 Ratings

- 4.3.1 Voltage: [30 Volts DC](#)
- 4.3.2 Current: [1.5 Amperes per pin](#)
- 4.3.3 Operating Temperature : [0°C to +55°C](#)  
Non-Operating Temperature : [-40°C to +85°C](#)

## 5 Performance

### 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.

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**ELECTRICAL**

Item	Requirement	Standard
Low-signal Level Contact Resistance	30 m $\Omega$ Max.(initial)per contact 15 m $\Omega$ Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	1000 M $\Omega$ Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	500V AC Min. at sea level for 1 minute. No discharge, flashover or breakdown. Current leakage: 0.5 m A max.	Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current after: 1.5 A/Power contact. The temperature rise above ambient shall not exceed 30°C The ambient condition is still air at 25°C (EIA-364-70 METHOD 2)

**MECHANICAL**

Durability	500 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 10 $\pm$ 3 mm/min, (200 cycles per hour max.) (EIA-364-09)
Mating / Un-mating Forces	Mating Force: 25N (2.55kgf) Max. Un-mating Force: 5N (0.5kgf) Min.	Operation Speed : 25.4 $\pm$ 3 mm/minute.. Measure the force required to mate/Un-mate connector. (EIA-364-13)
Terminal / Housing Retention Force	1.96N(0.2kgf) MIN.	Apply axial pull out force at the speed rate of 25.4 $\pm$ 3 mm/minute. On the terminal assembled in the housing.
Fitting nail / Housing Retention Force	1.96N(0.2kgf) MIN.	Apply axial pull out force at the speed rate of 25.4 $\pm$ 3 mm/minute. On the fitting nail assembled in the housing.
Vibration	1 $\mu$ s Max.	The electrical load condition shall be 100 m A maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz,

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		shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
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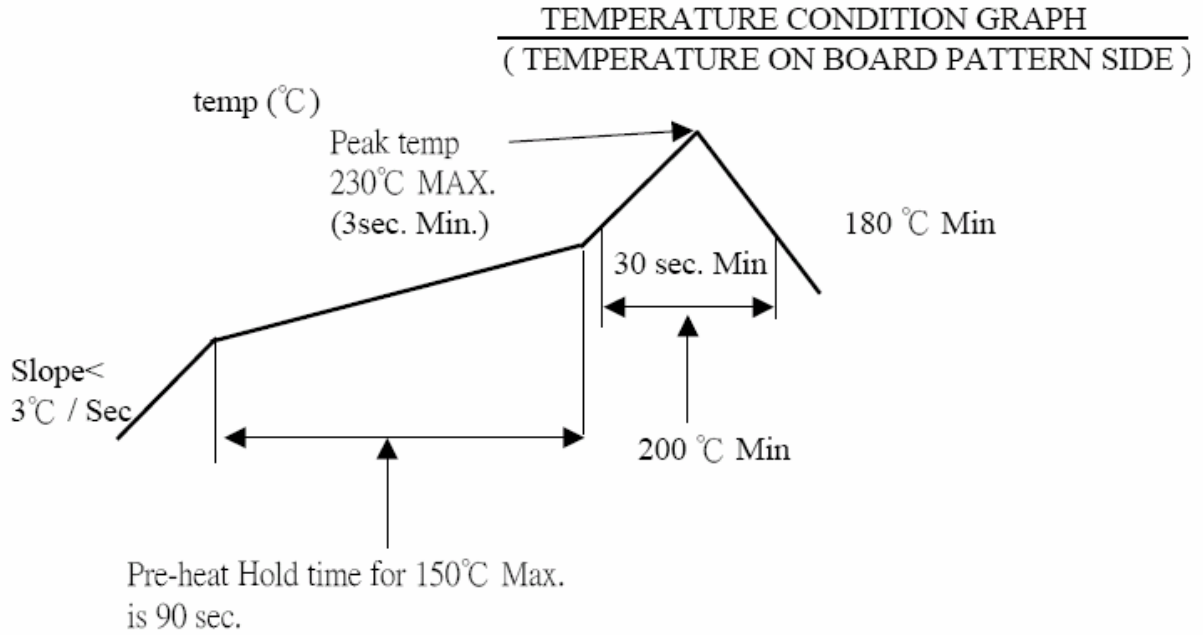
Shock (Mechanical)	1 $\mu$ s Max.	Subject mated connectors to <b>50 G's</b> (peak value) <b>half-sine</b> shock pulses of <b>11</b> milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition H)
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**ENVIRONMENTAL**

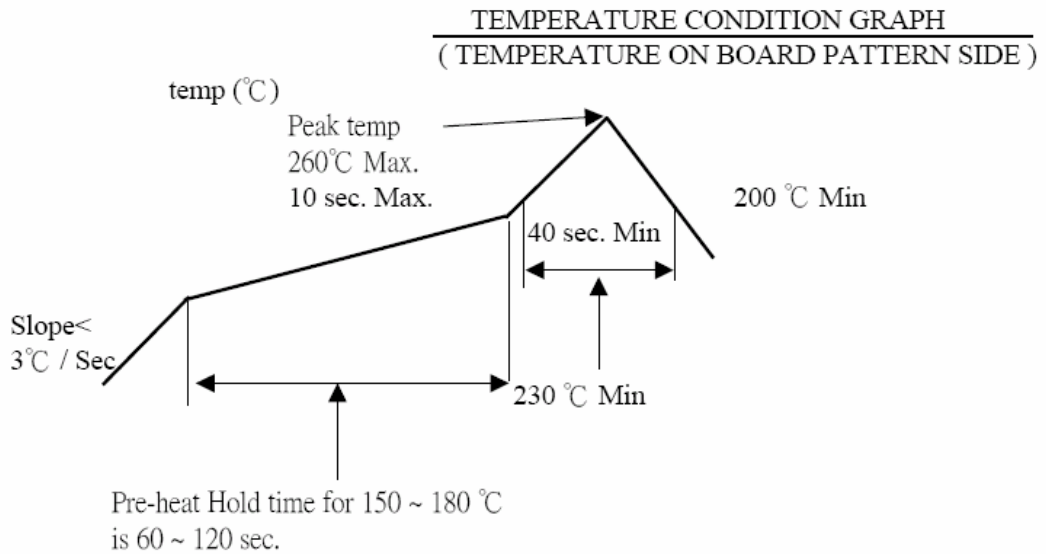
Hand Solder Ability	See Product Qualification and Test Sequence Group 6	Soldering iron : $350^{\circ}\text{C} \pm 10^{\circ}\text{C}$ Duration:3~4sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 3	Mate module and subject to follow condition for <b>10</b> cycles. 1 cycles: -55 +0/-3 $^{\circ}\text{C}$ , 30 minutes +85 +3/-0 $^{\circ}\text{C}$ , 30 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 3	Mated Connector $40^{\circ}\text{C}$ , 90~95% RH, 96Hour. Reefer to Method II. (EIA-364-31, Test condition A)
Temperature life	See Product Qualification and Test Sequence Group 4	Subject mated connectors to temperature life at <b><math>85^{\circ}\text{C}</math></b> for <b>500</b> hours. Measure Signal. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 5	Subject mated/unmated connectors to 5% salt-solution concentration, $35^{\circ}\text{C}$ for <b>48</b> hours. (EIA-364-26,Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage	And then into solder bath, Temperature at <b><math>260 \pm 5^{\circ}\text{C}</math></b> , for <b>4-5</b> sec. (EIA-364-52)

## 6 INFRARED REFLOW CONDITION

### 6.1. General Process



### 6.2. Lead-free Process



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**7 PRODUCT QUALIFICATION AND TEST SEQUENCE**

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8	9	10
	Test Sequence									
Examination of Product	1、7	1、6	1、7	1、6	1、4			1、3	1、3	
Low-signal Level Contact Resistance	2、6	2、5	2、10	2、9	2、5					
Insulation Resistance			3、9	3、8						
Dielectric Withstanding Voltage			4、8	4、7						
Mating / Unmating Forces	3、5									
Temperature rise									2	
Durability	4									
Contact Retention Force							1			
Vibration(Random) / Vibration		3								
Shock (Mechanical)		4								
Thermal Shock			5							
Humidity			6							
Temperature life				5						
Salt Spray					3					
Solder ability						1				
Resistance to Soldering Heat								2		
Sample Size	4	4	4	4	4	2	4	4	2	